



23 January 2025

NOTICE UNDER SECTION 708A OF THE CORPORATIONS ACT

This notice is given by 4DS Memory Limited (“Issuer”) under section 708A(5)(e) of the *Corporations Act 2001* (Cth) (“Act”).

The Issuer advises that it has today issued 152,777,777 fully paid ordinary shares in the capital of the Company (“Shares”), at an issue price of \$0.036 per Share pursuant to the placement announced on 17 January 2025 (“Placement”).

Pursuant to section 708A(5)(e) of the Act, the Issuer gives notice that:

- a) the Issued Shares were issued without disclosure to investors under Part 6D.2 of the Act;
- b) as at the date of this notice, the Issuer has complied with:
 - i. the provisions of Chapter 2M of the Act, as they apply to the Issuer; and
 - ii. section 674 and section 674A of the Act; and
- c) as at the date of this notice, there is no information that is ‘excluded information’ within the meaning of sections 708A(7) and 708A(8) of the Act which is required to be disclosed by the Issuer in accordance with section 708A(8) of the Act.

Authorised for release by the 4DS Board.

ENDS

Contact information

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4DS Interactive Investor Hub

If you have any questions on this announcement or any past 4DS announcements, check out our Investor Hub. Like, comment, ask a question and view video summaries on important announcements. Shareholders can link through to the Investor Hub via: [announcements.4dsmemory.com](https://www.4dsmemory.com/announcements)

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About 4DS

4DS Memory Limited (ASX: 4DS), with facilities located in Silicon Valley, is a semiconductor technology company bringing high bandwidth, high endurance, persistent non-volatile memory to advanced CMOS process nodes. Its technology, known as Interface Switching ReRAM, features tunable persistence and low energy per bit for today’s most challenging compute intensive and AI processor applications. Established in 2007, 4DS owns a patented IP portfolio, comprising 34 USA patents, and is the first company to develop PCMO ReRAM, on an advanced CMOS processing node. 4DS has three important industry relationships: a development agreement with Belgium based imec, a world leading research and innovation hub in nano electronics and digital technologies; a design agreement with Infineon Technologies AG, Germany’s largest semiconductor manufacturer and one of the ten largest semiconductor manufacturers worldwide; and a joint development agreement with Western Digital subsidiary HGST, a global leader in storage solutions.

For more information, please visit www.4dsmemory.com